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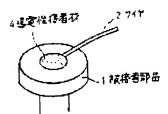
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(54) WIRE CONNECTING METHOD

(57)Abstract:

PURPOSE: To prevent disconnections by applying conductive adhesives to a crushed section by wire bonding and reinforcing the crushed section.

CONSTITUTION: When a small-gage wire 2 consisting of Au, etc. is bonded with a part to be bonded such as a terminal, a joining section is crushed. When conductive adhesives 4 are applied to the joining section and cured, the joining section is reinforced, thus preventing disconnections.



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